

April 2013

FDPF320N06L

N-Channel PowerTrench[®] MOSFET 60 V, 21 A, 25 m Ω

Features

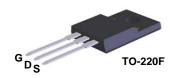
- $R_{DS(on)} = 20 \text{ m}\Omega \text{ (Typ.)} @ V_{GS} = 10 \text{ V, } I_D = 21 \text{ A}$
- $R_{DS(on)} = 23 \text{ m}\Omega \text{ (Typ.)} @ V_{GS} = 5 \text{ V, } I_D = 17 \text{ A}$
- Low Gate Charge (Typ. 23.2 nC)
- Low C_{rss} (Typ. 64 pF)
- · Fast Switching
- 100% Avalanche Tested
- · Improved dv/dt Capability
- RoHS Compliant

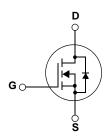
Description

This N-Channel MOSFET is produced using Fairchild Semiconductor[®]'s PowerTrench[®] process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

Applications

- · Consumer Appliances
- LCD / LED / PDP TV





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted*

Symbol		Parameter		FDPF320N06L	Unit	
V _{DSS}	Drain to Source Voltage			60	V	
V _{GSS}	Gate to Source Voltage			±20	V	
1	Drain Current	- Continuous (T _C = 25°C)		21	А	
ID	Drain Current	- Continuous (T _C = 100°C)		15	_ A	
I _{DM}	Drain Current	- Pulsed	(Note 1)	84	Α	
E _{AS}	Single Pulsed Avalanche Ene	rgy	(Note 2)	66	mJ	
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	6.0	V/ns	
D	Davier Dissipation	$(T_C = 25^{\circ}C)$		26	W	
P_{D}	Power Dissipation	- Derate above 25°C		0.17	W/°C	
T _J , T _{STG}	Operating and Storage Tempo	erature Range		-55 to +175	οС	
T _L	Maximum Lead Temperature 1/8" from Case for 5 Seconds	• •		300	°C	

^{*}Drain current limited by maximum junction temperature

Thermal Characteristics

Symbol	Parameter FDPF320N06L		Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	5.8	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	*C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDPF320N06L	FDPF320N06L	TO-220F	=	-	50

Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter Test Conditions		Min.	Тур.	Max.	Unit
Off Charac	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	60	-	-	V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250\mu\text{A}$, Referenced to 25°C	-	0.04	-	V/°C
ı	Zero Gate Voltage Drain Current	V _{DS} = 48V, V _{GS} = 0V	-	-	1	μА
IDSS	Zero Gate voltage Drain Current	$V_{DS} = 48V, T_C = 150^{\circ}C$	-	-	500	μΑ
I _{GSS}	Gate to Body Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$	-	-	±100	μА

On Characteristics

V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	1.0	-	2.5	V
D	Static Drain to Source On Resistance	$V_{GS} = 10V, I_D = 21A$	-	20	25	mΩ
Static Drain to Source On Resistance	$V_{GS} = 5V, I_{D} = 17A$	-	23	38	mΩ	
9 _{FS}	Forward Transconductance	$V_{DS} = 10V, I_{D} = 21A$	-	34	-	S

Dynamic Characteristics

C _{iss}	Input Capacitance	V 051/ 1/ 01/		-	1105	1470	pF
C _{oss}	Output Capacitance	$V_{DS} = 25V, V_{GS} = 0$ f = 1MHz	$V_{DS} = 25V, V_{GS} = 0V$		115	150	pF
C _{rss}	Reverse Transfer Capacitance	1 = 11VII 12		-	64	-	pF
Q _{g(tot)}	Total Gate Charge at 10V	V _{GS} = 10V		-	23.2	30.2	nC
Q _{g(tot)}	Total Gate Charge at 5V	$V_{GS} = 5V$.,	-	12.7	16.5	nC
Q_{gs}	Gate to Source Gate Charge		V _{DS} = 48V I _D = 21A	-	3.4	-	nC
Q _{gd}	Gate to Drain "Miller" Charge		$I_D = 2IA$ (Note 4)	-	6.3	-	nC

Switching Characteristics

t _{d(on)}	Turn-On Delay Time		-	16	42	ns
t _r	Turn-On Rise Time	$V_{DD} = 30V, I_D = 21A$	-	34	78	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 5V$, $R_{GEN} = 4.7\Omega$	-	27	64	ns
t _f	Turn-Off Fall Time	(Note 4)	-	8	26	ns
ESR	Equivalent Series Resistance (G-S)	f = 1MHz	-	2	-	Ω

Drain-Source Diode Characteristics

IS	Maximum Continuous Drain to Source Diode Forward Current		-	-	21	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	84	Α
V_{SD}	Drain to Source Diode Forward Voltage	$V_{GS} = 0V, I_{SD} = 21A$	-	-	1.3	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0V, I_{SD} = 21A, V_{DD} = 48V$	-	27	-	ns
Q _{rr}	Reverse Recovery Charge	$dI_F/dt = 100A/\mu s$	-	23	-	nC

- **Notes:**1. Repetitive Rating: Pulse width limited by maximum junction temperature
- 2. L = 1mH, I_{AS} = 11.5A, R_G = 25 Ω , Starting T_J = 25°C
- 3. $I_{SD} \le 21 \text{A}$, di/dt $\le 200 \text{A}/\mu \text{s}$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ} C$
- 4. Essentially Independent of Operating Temperature Typical Characteristics

Typical Performance Characteristics

Figure 1. On-Region Characteristics

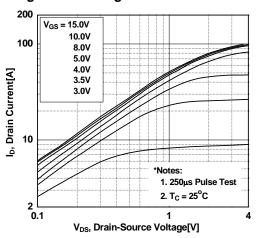


Figure 3. On-Resistance Variation vs.

Drain Current and Gate Voltage

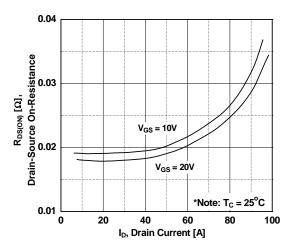


Figure 5. Capacitance Characteristics

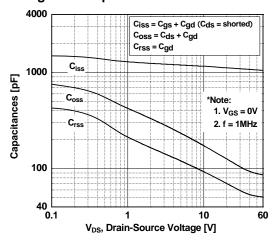


Figure 2. Transfer Characteristics

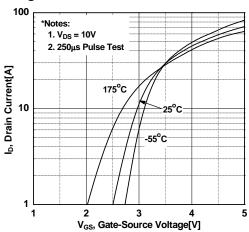


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

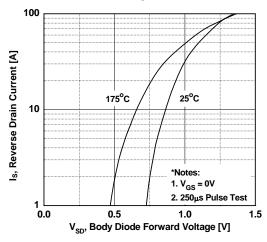
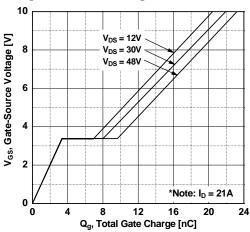


Figure 6. Gate Charge Characteristics



Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

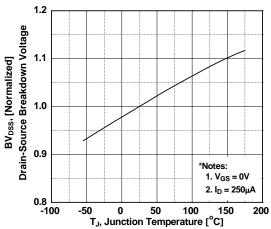


Figure 9. Maximum Safe Operating Area

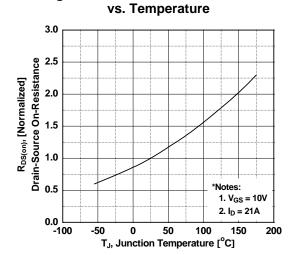
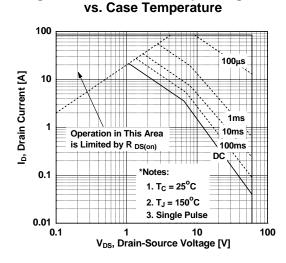


Figure 8. On-Resistance Variation

Figure 10. Maximum Drain Current



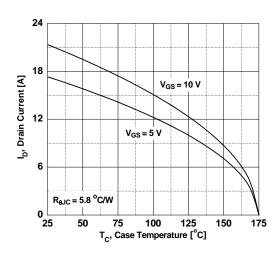
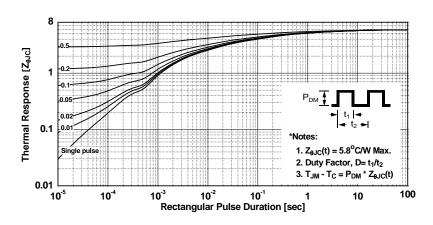
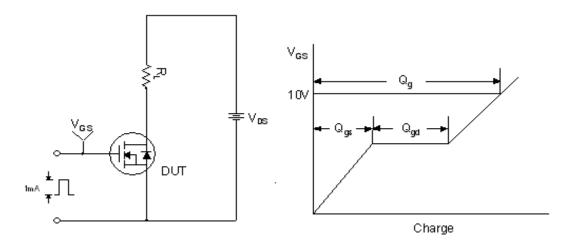


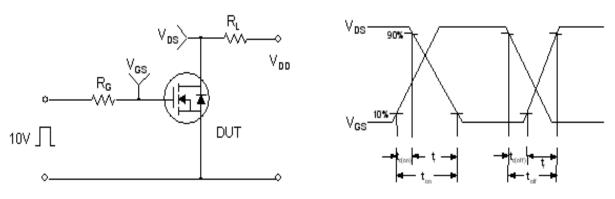
Figure 11. Transient Thermal Response Curve



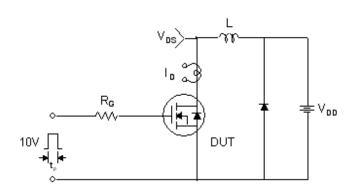
Gate Charge Test Circuit & Waveform

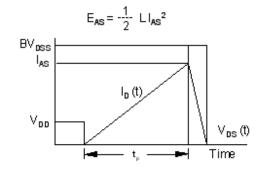


Resistive Switching Test Circuit & Waveforms

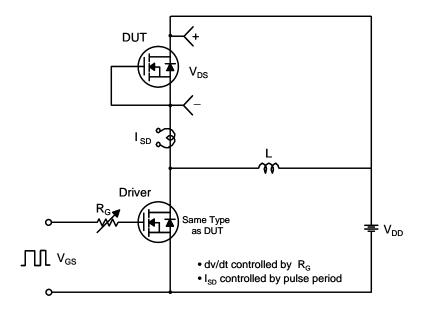


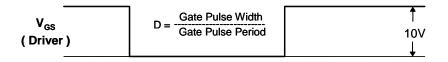
Unclamped Inductive Switching Test Circuit & Waveforms

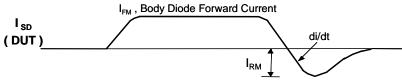




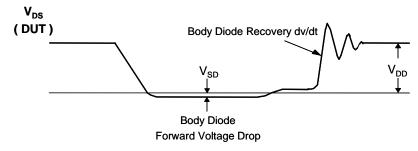
Peak Diode Recovery dv/dt Test Circuit & Waveforms





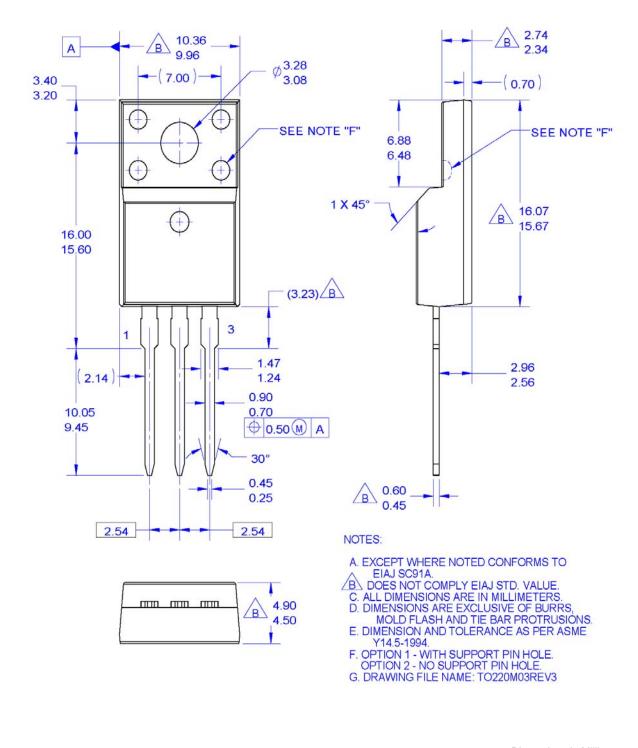


Body Diode Reverse Current



Mechanical Dimensions

TO-220M03







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